查<mark>询"EDD6782A"供应</mark>商 FAIRCHILD

SEMICONDUCTOR®

FDD6782A N-Channel PowerTrench[®] MOSFET

25 V, 10.5 m Ω

Features

- Max $r_{DS(on)}$ = 10.5 m Ω at V_{GS} = 10 V, I_D = 14.9 A
- Max $r_{DS(on)}$ = 24.0 m Ω at V_{GS} = 4.5 V, I_D = 11.0 A
- 100% UIL test
- RoHS Compliant

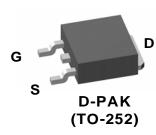


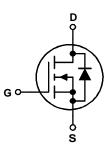
General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$ and fast switching speed.

Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture





MOSFET Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		20		
	-Continuous (Silicon limited)	T _C = 25 °C		42	•	
ID	-Continuous	T _A = 25 °C	(Note 1a)	20	Α	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	12	mJ	
P _D	Power Dissipation	T _C = 25 °C		31	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.7		
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +175	°C	

Thermal Characteristics

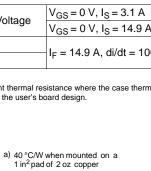
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note	a) 40	0/11

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6782A	FDD6782A	D-PAK (TO-252)	13 "	12 mm	2500 units

January 2009

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		16		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
		V _{GS} = 10 V, I _D = 14.9 A		8.3	10.5	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 11.0 A		17.8	24.0	
		V_{GS} = 10 V, I _D = 14.9 A, T _J = 150 °	C	12.7	16.1	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 14.9 A		60		S
C _{iss} C _{oss}	Input Capacitance Output Capacitance	V _{DS} = 13 V, V _{GS} = 0 V, f = 1MHz		800 162	1065 220	pF pF
C _{rss}	Reverse Transfer Capacitance			151	230	pF
Rg	Gate Resistance	f = 1MHz		1.0		Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			7	14	ns
t _r	Rise Time	V _{DD} = 13 V, I _D = 14.9 A,		3	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		15	27	ns
t _f	Fall Time	-		2	4	ns
, Q _q	Total Gate Charge	$V_{GS} = 0 V$ to 10 V	1	15	27	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 13 V,$		8	16	nC
Q _{gs}	Gate to Source Charge	I _D = 14.9 A		2.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			3.2		nC
Drain-So	urce Diode Characteristics					
N/	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 3.1 A$ (Note 2	2)	0.8	1.2	V
V _{SD}		$V_{GS} = 0 V, I_S = 14.9 A$ (Note 2	2)	0.9	1.3	v
t _{rr}	Reverse Recovery Time	I _F = 14.9 A, di/dt = 100 A/μs		14	26	ns
Q _{rr}	Reverse Recovery Charge			4	10	nC





b) 96 °C/W when mounted on a minimum pad.

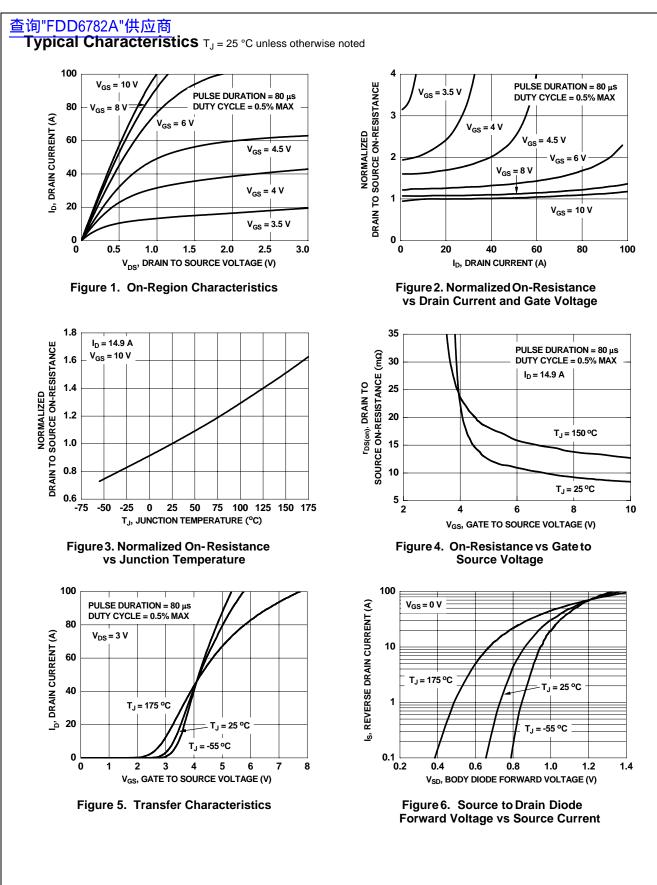


2: Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. **3:** E_{AS} of 12 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 5 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 12 A.

©2009 Fairchild Semiconductor Corporation FDD6782A Rev.C

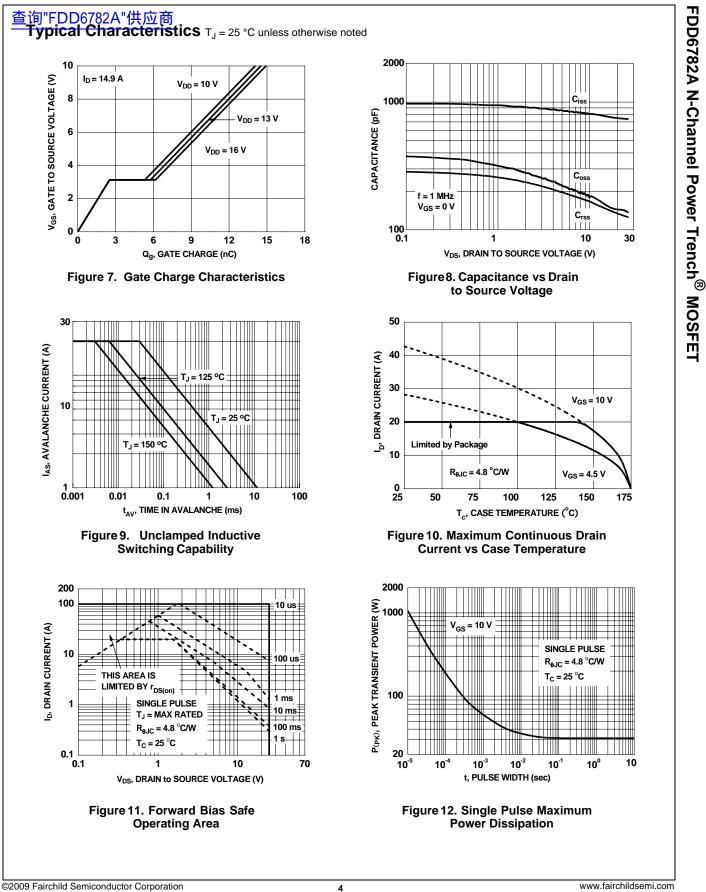
www.fairchildsemi.com

FDD6782A N-Channel Power Trench[®] MOSFET

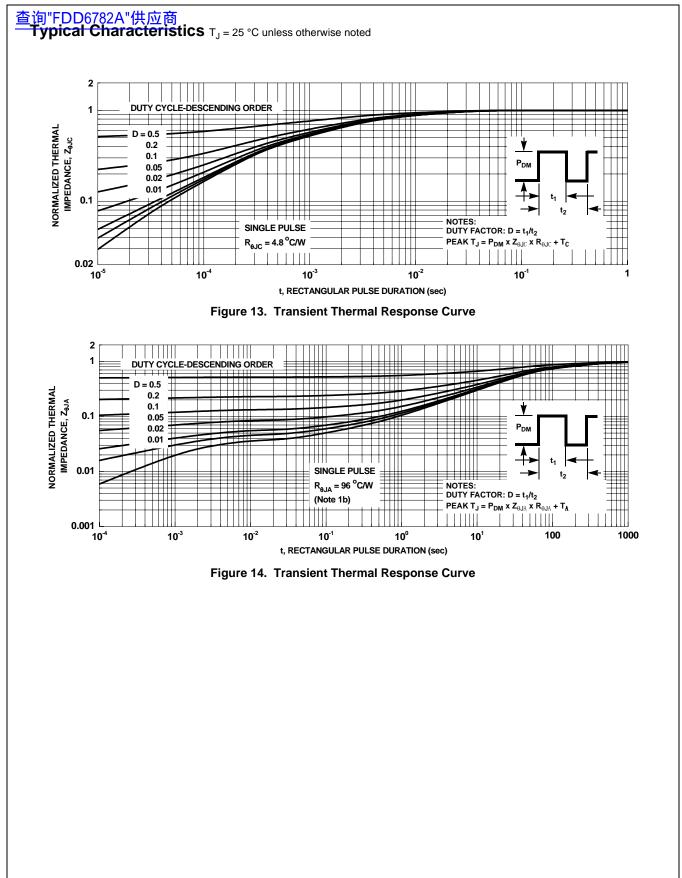


©2009 Fairchild Semiconductor Corporation FDD6782A Rev.C

www.fairchildsemi.com



FDD6782A Rev.C



FDD6782A N-Channel Power Trench[®] MOSFET

查询"FDD6782A"供应商

FAIRCHILD

SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now TM CorePLUS TM COREPOWER TM CROSSVOL7 TM CTL TM Current Transfer Logic TM EcoSPARK [®] EfficentMax TM ESWITCHTM $*$ T T T T T T T T T T T T T T T T T T T	FRFET [®] Global Power Resource SM Green FPST ^M e-Series TM GTOT ^M IntelliMAXT ^M ISOPLANAR TM MegaBuck TM MiCROCOUPLER TM MiCROCOUPLER TM MiCROCOUPLER TM MicroPak TM MillerDrive TM Motion-SPM TM OPTOLOGIC [®] OPTOPLANAR [®] [®] PDP SPM TM Power-SPM TM Power-SPM TM PowerTrench [®] PowerXS TM	Programmable Active Droop™ QFET® QS™ Quiet Series™ RapidConfigure™ Por world, 1mW /W /kW at a time™ Saving our world, 1mW /W /kW at a time™ SmartMax™ SMART START™ SMART START™ SMPR® STEALTH™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SuperSot™-8 SuperSot	The WEF Firanchise TinyBoost TM TinyBuck TM TinyPoyter TM TinyPower TM TinyPower TM TinyPWM TM
---	---	--	---

* EZSWITCH™ and FlashWriter[®] are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Farichild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Farichild strongly encourages customers to purchase Farichild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Farichild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Farichild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.